

NOT RECOMMENDED FOR **NEW DESIGN, USE** MMSZ52xxB

1N5221B - 1N5267B

Features

- 500mW Power Dissipation
- High Stability
- Surface Mount Equivalents Available
- Hermetic Package
- Vz Tolerance ±5%
- Lead Free Finish, RoHS Compliant (Note 2)

Mechanical Data

Case: DO-35

Case Material: Glass

Moisture Sensitivity: Level 1 per J-STD-020C

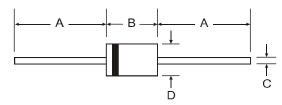
Leads: Solderable per MIL-STD-202, Method 208

Terminals: Finish - Sn96.5Ag3.5. Solderable per MIL-STD-202, Method 208

Polarity: Cathode Band

Marking: Type Number

Weight: 0.13 grams (approximate)



DO-35				
Dim	Min	Max		
Α	25.40	_		
В		4.00		
C		0.60		
D	_	2.00		
All Dimensions in mm				

Maximum Ratings and Electrical Characteristics @TA = 25°C unless otherwise specified

Chai	acteristic	Symbol	Value	Unit
Power Dissipation (Note 1)		P_d	500	mW
Thermal Resistance, Junction	to Ambient Air (Note 1)	$R_{ heta JA}$	300	°C/W
Forward Voltage	@ I _F = 200mA	V _F	1.1	V
Operating and Storage Temper	rature Range	T _{i.} T _{STG}	-65 to +200	°C

Notes:

- 1. Valid provided that leads are kept at TL ≤75°C with lead length = 9.5mm (3/8") from case; derate above 75°C.
- 2. EC Directive 2002/95/EC (RoHS) revision 13.2.2003. Glass and high temperature solder exemptions applied where applicable, see EU Directive Annex Notes 5 and 7.



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Electrical Characteristics

@T_A = 25°C unless otherwise specified

Table 1

Nom (V) Min (V) Max (V) mA 1N5221B 2.4 2.28 2.52 20 1N5222B 2.5 2.38 2.63 20 1N5223B 2.7 2.57 2.84 20	Ω Section 20 Section 20	Z _{ZK} @ I _{ZK} = 0.25mA Ω	I _R μΑ	@V _R	Coefficient
1N5221B 2.4 2.28 2.52 20 1N5222B 2.5 2.38 2.63 20 1N5223B 2.7 2.57 2.84 20	30		11/		@ I _{ZT}
1N5222B 2.5 2.38 2.63 20 1N5223B 2.7 2.57 2.84 20		4000	μΛ	V	%/°C
1N5223B 2.7 2.57 2.84 20	30	1200	100	1.0	-0.085
		1250	100	1.0	-0.085
1)170017	30	1300	75	1.0	-0.080
1N5224B 2.8 2.66 2.94 20	30	1400	75	1.0	-0.080
1N5225B 3.0 2.85 3.15 20	29	1600	50	1.0	-0.075
1N5226B 3.3 3.14 3.47 20	28	1600	25	1.0	-0.070
1N5227B 3.6 3.42 3.78 20	24	1700	15	1.0	-0.065
1N5228B 3.9 3.71 4.10 20	23	1900	10	1.0	-0.060
1N5229B 4.3 4.09 4.52 20	22	2000	5.0	1.0	+0.055
1N5230B 4.7 4.47 4.94 20	19	1900	5.0	2.0	+0.030
1N5231B 5.1 4.85 5.36 20	17	1600	5.0	2.0	+0.030
1N5232B 5.6 5.32 5.88 20	11	1600	5.0	3.0	+0.038
1N5233B 6.0 5.70 6.30 20	7.0	1600	5.0	3.5	+0.038
1N5234B 6.2 5.89 6.51 20	7.0	1000	5.0	4.0	+0.045
1N5235B 6.8 6.46 7.14 20	5.0	750	3.0	5.0	+0.050
1N5236B 7.5 7.13 7.88 20	6.0	500	3.0	6.0	+0.058
1N5237B 8.2 7.79 8.61 20	8.0	500	3.0	6.5	+0.062
1N5238B 8.7 8.27 9.14 20	8.0	600	3.0	6.5	+0.065
1N5239B 9.1 8.65 9.56 20	10	600	3.0	7.0	+0.068
1N5240B 10 9.50 10.50 20	17	600	3.0	8.0	+0.075
1N5241B 11 10.45 11.55 20	22	600	2.0	8.4	+0.076
1N5242B 12 11.40 12.60 20	30	600	1.0	9.1	+0.077
1N5243B 13 12.35 13.65 9.5	13	600	0.5	9.9	+0.079
	15	600	0.1	10	+0.082
	16	600	0.1	11	+0.082
	17	600	0.1	12	+0.083
	19	600	0.1	13	+0.084
	21	600	0.1	14	+0.085
	23	600	0.1	14	+0.086
	25	600	0.1	15	+0.086
	29	600	0.1	17	+0.087
	33	600	0.1	18	+0.087
	35	600	0.1	19	+0.089
	41	600	0.1	21	+0.090
	44	600	0.1	21	+0.091
	49	600	0.1	23	+0.091
	58	700	0.1	25	+0.092
	70	700	0.1	27	+0.093
	80	800	0.1	30	+0.094
	93	900	0.1	33	+0.095
	105	1000	0.1	36	+0.095
	125	1100	0.1	39	+0.096
	150	1300	0.1	43	+0.096
	170	1400	0.1	46	+0.097
	185	1400	0.1	47	+0.097
	230	1600	0.1	52	+0.097
	270	1700	0.1	56	+0.098

3. Based on dc measurement at thermal equilibrium; lead length = 9.5mm (3/8"); thermal resistance of heat sink = 30°C/W. Notes:



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Ordering Information (Notes 4 & 5)

Device	Packaging	Shipping
(Type Number)-A*	DO-35	5K/Ammo Pack
(Type Number)-T*	DO-35	5K/Tape & Reel

4. *Add "-A" or "-T" to the appropriate type number in Table 1. Example: 6.2V Zener = 1N5234B-A for ammo pack. Notes:

5. For packaging details, visit our website at http://www.diodes.com/datasheets/ap02008.pdf.

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